

August 1997 Revised December 1999

### FST3126 Quad Bus Switch

#### **General Description**

The Fairchild Switch FST3126 provides four high-speed CMOS TTL-compatible bus switches. The low on resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise.

The device is organized as four 1-bit switches with separate OE inputs. When OE is HIGH, the switch is ON and Port A is connected to Port B. When OE is LOW, the switch is OPEN and a high-impedance state exists between the two ports.

#### **Features**

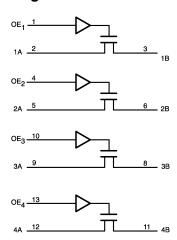
- $\blacksquare$  4 $\Omega$  switch connection between two ports.
- Minimal propagation delay through the switch.
- Low I<sub>CC</sub>.
- Zero bounce in flow-through mode.
- Control inputs compatible with TTL level.

#### **Ordering Code:**

Order Number	Package Number	Package Description
FST3126M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow
FST3126QSC	MQA16	16-Lead Quarter Size Outline Package (QSOP), JEDEC MO-137, 0.150 Wide
FST3126MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

#### **Logic Diagram**



#### **Pin Descriptions**

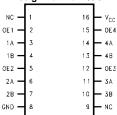
Pin Name	Description				
$OE_1$ , $OE_2$ , $OE_3$ , $OE_4$	Bus Switch Enables				
1A, 2A, 3A, 4A	Bus A				
1B, 2B, 3B, 4B	Bus B				
NC	Not Connected				

#### **Connection Diagrams**

#### Pin Assignment for SOIC and TSSOP

_				
OE <sub>1</sub>	1	$\bigcup$	14	_ v <sub>cc</sub>
1A —	2		13	- OE₄
1B —	3		12	— 4A
0E <sub>2</sub> -	4		11	— 4B
2A —	5		10	- OE3
2B —	6		9	— за
GND —	7		8	— зв

#### Pin Assignment for QSOP



#### **Truth Table**

Inputs	Inputs/Outputs
OE	A,B
L	Z
Н	A = B

#### Absolute Maximum Ratings(Note 1)

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# Recommended Operating Conditions (Note 3)

 $\begin{array}{lll} \mbox{Power Supply Operating ($V_{CC}$)} & 4.0 \mbox{V to } 5.5 \mbox{V} \\ \mbox{Input Voltage ($V_{IN}$)} & 0 \mbox{V to } 5.5 \mbox{V} \\ \mbox{Output Voltage ($V_{OUT}$)} & 0 \mbox{V to } 5.5 \mbox{V} \\ \end{array}$ 

Input Rise and Fall Time (t<sub>r</sub>, t<sub>f</sub>)

Switch Control Input 0nS/V to 5nS/V Switch I/O 0nS/V to DC Free Air Operating Temperature ( $T_A$ ) -40 °C to +85 °C

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum rating. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Note 3: Unused control inputs must be held high or low. They may not float.

#### **DC Electrical Characteristics**

	Parameter	V <sub>CC</sub> (V)	$T_A = -40  ^{\circ}\text{C} \text{ to } +85  ^{\circ}\text{C}$				
Symbol			Min	Typ (Note 4)	Max	Units	Conditions
V <sub>IK</sub>	Clamp Diode Voltage	4.5			-1.2	V	I <sub>IN</sub> = -18mA
V <sub>IH</sub>	HIGH Level Input Voltage	4.0-5.5	2.0			V	
V <sub>IL</sub>	LOW Level Input Voltage	4.0-5.5			0.8	V	
II	Input Leakage Current	5.5			±1.0	μΑ	0≤ V <sub>IN</sub> ≤5.5V
I <sub>OZ</sub>	OFF-STATE Leakage Current	5.5			±1.0	μΑ	0 ≤A, B ≤V <sub>CC</sub>
R <sub>ON</sub>	Switch On Resistance	4.5		4	7	Ω	V <sub>IN</sub> = 0V, I <sub>IN</sub> = 64mA
	(Note 5)	4.5		4	7	Ω	V <sub>IN</sub> = 0V, I <sub>IN</sub> = 30mA
		4.5		8	15	Ω	V <sub>IN</sub> = 2.4V, I <sub>IN</sub> = 15mA
		4.0		11	20	Ω	V <sub>IN</sub> = 2.4V, I <sub>IN</sub> = 15mA
I <sub>CC</sub>	Quiescent Supply Current	5.5			3	μΑ	V <sub>IN</sub> = V <sub>CC</sub> or GND,
							I <sub>OUT</sub> = 0
$\Delta I_{CC}$	Increase in I <sub>CC</sub> per Input	5.5			2.5	mA	One input at 3.4V.
							Other inputs at V <sub>CC</sub> or GND

Note 4: Typical values are at  $V_{CC} = 5.0V$  and  $T_A = +25^{\circ}C$ 

Note 5: Measured by the voltage drop between A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltages on the two (A or B) pins.

### **AC Electrical Characteristics**

Symbol	Parameter	$T_A = -40$ °C to +85 °C, $C_L = 50$ pF, RU = RD = $500\Omega$						
		$V_{CC} = 4.5 - 5.5V$		V <sub>CC</sub> = 4.0V		Units	Conditions	Figure No.
		Min	Max	Min	Max			Ì
t <sub>PHL</sub> ,t <sub>PLH</sub>	Prop Delay Bus to Bus (Note 6)		0.25		0.25	ns	V <sub>I</sub> =OPEN	Figure 1 Figure 2
t <sub>PZH</sub> , t <sub>PZL</sub>	Output Enable Time	1.0	4.5		5.0	ns	$V_I = 7V$ for $t_{PZL}$ $V_I = OPEN$ for $t_{PZH}$	Figure 1 Figure 2
t <sub>PHZ</sub> , t <sub>PLZ</sub>	Output Disable Time	1.5	5.7		6.2	ns	$V_I = 7V$ for $t_{PLZ}$ $V_I = OPEN$ for $t_{PHZ}$	Figure 1 Figure 2

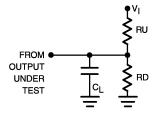
Note 6: This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On resistance of the switch and the 50pF load capacitance, when driven by an ideal voltage source (zero output impedance).

#### Capacitance (Note 7)

Symbol	Parameter	Тур	Max	Units	Conditions
C <sub>IN</sub>	Control Pin Input Capacitance	3		pF	V <sub>CC</sub> = 5.0V
C <sub>I/O</sub>	Input/Output Capacitance	5		pF	$V_{CC} = 5.0V, OE = 0V$

Note 7:  $T_A = +25^{\circ}C$ , f = 1 MHz, Capacitance is characterized but not tested.

#### **AC Loading and Waveforms**



Note: Input driven by 50  $\Omega$  source terminated in 50  $\Omega$  Note:  $C_L$  includes load and stray capacitance Note: Input PRR = 1.0MHz,  $t_W$  = 500ns

FIGURE 1. AC Test Circuit

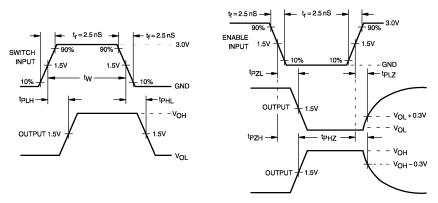
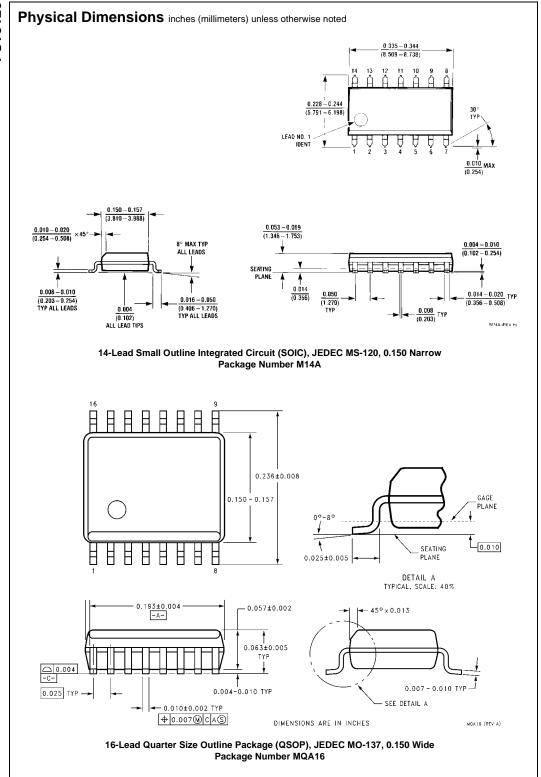
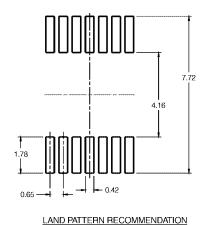


FIGURE 2. AC Waveforms

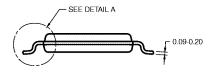


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Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



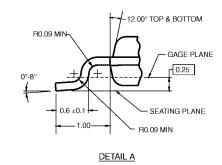
1.2 MAX ALL LEAD TIPS 0.90 +0.15 0.10 c 0.10 +0.05 0.10 +0.15 0.19 +0.30 0.10 +0.05 0.13 @ A B © C ©



#### NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB, REF NOTE 6, DATE 7/93.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MTC14RevC3



14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC14

#### **Technology Description**

The Fairchild Switch family derives from and embodies Fairchild's proven switch technology used for several years in its 74LVX3L384 (FST3384) bus switch product.

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